## Special Issue

## Hardware-Aware Deep Learning

## Message from the Guest Editors

One of the main factors that contributes to the success of deep learning (DL) is the mighty computing power provided by modern hardware, spanning from highperformance server systems to resource-limited edge devices. The edge side (e.g., embedded systems, IoT) demands not only extreme energy-efficiency but also real-time inference capability, which requires crossstack techniques, including model compression, compilation, architecture and circuit design of Al chips, emerging devices, etc. On the cloud side, as the DL model size grows exponentially in the last two years (e.g., OpenAl GPT3, Google switch-transformer, etc.), how to efficiently support the training and inference of those immerse models is also an emerging research direction. Without lowering their hardware cost. however, incorporating them into the paradigm of machine learning as a service (MLaaS) will be infeasible. Therefore, the aforementioned concerns motivate the research of hardware-aware deep learning, for optimized energy, latency, and even security.

## **Guest Editors**

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## Deadline for manuscript submissions

closed (20 May 2023)



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## Editor-in-Chief

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